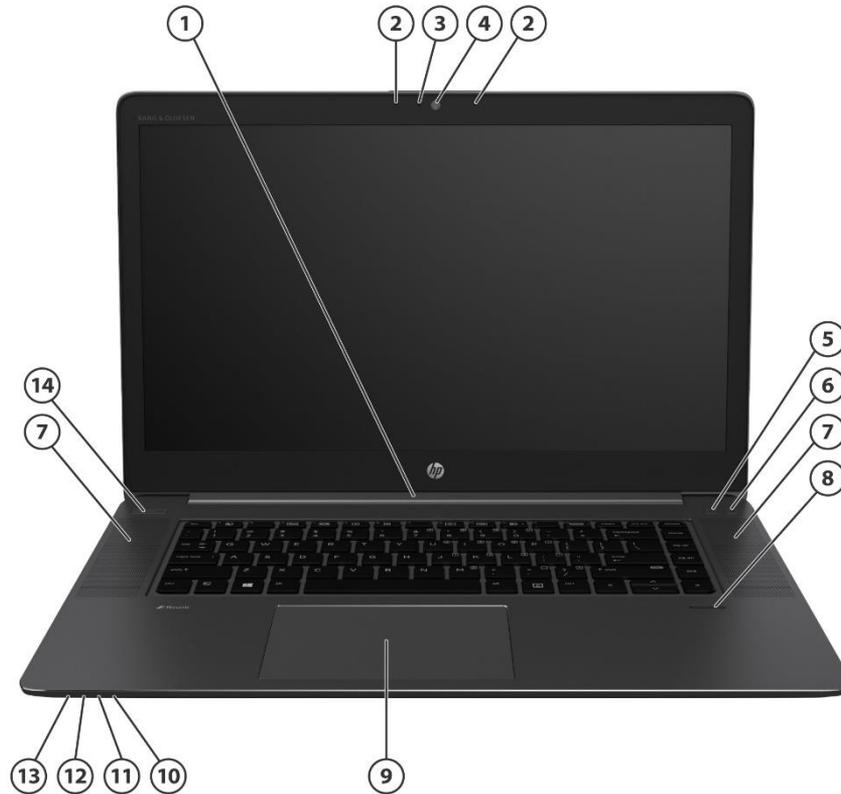


Overview

HP ZBook Studio G3 Mobile Workstation

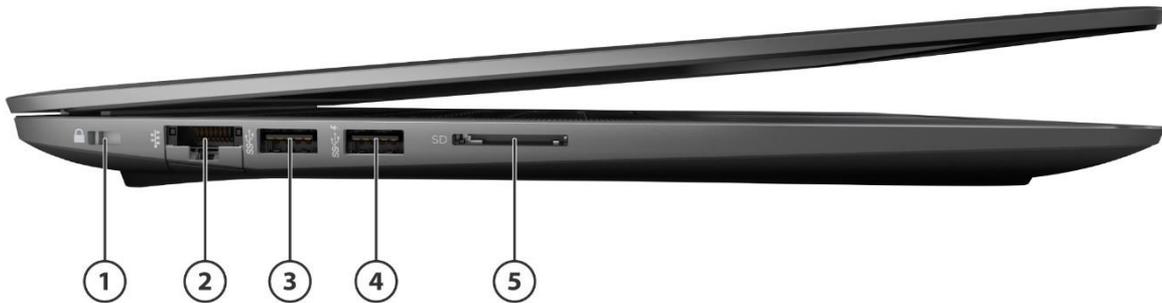
FRONT VIEW



- | | | | |
|----|---|-----|--------------------------|
| 1. | WLAN Antennas (2) | 9. | Clickpad |
| 2. | Internal microphones (2) | 10. | Storage light indicator |
| 3. | Webcam Light (with webcam) | 11. | Battery light indicator |
| 4. | Optional 720p HD Webcam | 12. | Power light indicator |
| 5. | Wireless button | 13. | Wireless light indicator |
| 6. | Volume mute button | 14. | Power button |
| 7. | Speakers | | |
| 8. | Fingerprint reader (select models only) | | |

Overview

LEFT VIEW



- | | |
|-----------------------|--------------------------|
| 1. Security lock slot | 4. USB 3.0 port Charging |
| 2. RJ-45 (Ethernet) | 5. SD Card reader |
| 3. USB 3.0 port | |

RIGHT VIEW



- | | |
|---|-----------------------------|
| 1. Audio in (microphone) / Audio-out (headphone) jack | 4. (2) Thunderbolt™ 3 ports |
| 2. USB 3.0 port | 5. Power connector |
| 3. HDMI 1.4 port | 6. Power LED |

Overview

At A Glance

- Windows® 10 editions, Windows® 7 editions, or FreeDOS
- Thin & light full performance industrial design, CNC machined top cover and keyboard deck. Top cover anodized in HP's new "Space Silver" color with chemical etching. Bottom housing is constructed out of lightweight magnesium for durability. 2 piece aluminum vented bottom cover for airflow. Backlight keyboard in full aluminum deck, chemically strengthened glass large clickpad, and updated system functions indicators. Diamond cut process showcased around keyboard deck and clickpad.
- HP Spill Resistant Keyboard with Durakeys
- Designed to pass military standard Mil-Std-810G testing
- Workstation-caliber NVIDIA® Quadro® discrete graphics, HP ZBook Studio special edition: NVIDIA® Quadro® M1000M (with 4GB dedicated GDDR5 graphics memory); NVIDIA® Optimus.
- Intel Integrated graphics: Intel® HD Graphics 530 integrated on Core™ i7. Intel® HD Graphics P530 and Intel® Iris Pro Graphics P580 integrated on Xeon® processors.
- ISV certified to provide fast and reliable performance with workstation applications, including manipulation of 3D textures (**Note: HD 530 will not be ISV certified**)
- Choice of 6th generation Intel® Core™ i7 and i5 quad-core or Xeon® processors.
- Intel® Core™ i7 with vPro or Intel® Xeon® with vPro technology (optional)
- HP Performance Advisor for optimal configuration, compatibility and performance
- Up to two SODIMMs, for system memory up to 32GB. ECC memory with Intel® Xeon® processors.
- Supports multi-display, including up to three displays without the use of a docking solution, with hybrid graphics enabled. Supports up to five with HP ZBook Dock with Thunderbolt™ 3 (sold separately), with hybrid graphics enabled.
- Two (2) Thunderbolt™ 3 ports (supporting DP 1.2, USB 3.1, PCIe Gen 3 devices) on the new USB-C™ connector, for high speed data/video/audio transfer support.
- Bang and Olufsen audio optimized for high fidelity audio with immersive surround sound with deep, rich bass and crystal clear dialog without distortion at high volume
- Long life battery solution: 4-cell (64 WHr)
- 2 discrete buttons with LED indicator for convenient one touch access - Wireless On/Off, Volume Mute
- Widescreen 15.6-inch diagonal anti-glare LED-backlit display:
FHD (1920x1080) ultrawide viewing angle, UHD (3840x2160) ultrawide viewing angle, UHD (3840x2160) ultrawide viewing angle with HP DreamColor Technology, or FHD Touch (1920x1080) ultrawide viewing angle
- Wireless connectivity options:
 - Intel® Dual Band Wireless-AC 8260 802.11 ac/a/b/g/n (2x2) WiFi and Bluetooth® 4.2 combo (vPro) or,
 - Intel® Dual Band Wireless-AC 8260 802.11 ac/a/b/g/n (2x2) WiFi and Bluetooth® 4.2 combo (non-vPro)
- Two dedicated drive slots. (2) M.2 slots. Both can be populated at a time.
- Security features including HP Client Security Manager, managed via single console.
- Low halogen HP BIOS technology, including HP Sure Start to identify and recover from unknown BIOS attacks.

NOTE: See important legal disclosures for all listed specs in their respective features sections.

Features

OPERATING SYSTEM

Preinstalled

Windows® 10 Pro 64*
Windows® 10 Home 64*
Windows® 7 Professional 64 (available through downgrade rights from Windows® 10 Pro) **
Windows® 7 Professional 64*
FreeDOS 2.0

Supported

Windows® 10 Enterprise 64*
Windows® 7 Enterprise 64*
Red Hat® Enterprise Linux® Desktop 6, 7

* Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See <http://www.microsoft.com>.

**This system is preinstalled with Windows 7 Professional software and also comes with a license and media for Windows 10 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

NOTE: For detailed OS/hardware support information for Linux®, see: http://www.hp.com/support/linux_hardware_matrix

PROCESSOR*

Intel® Xeon® E3-1545M v5 with Intel® Iris Pro Graphics P580 (2.90 GHz, 2133 MHz, 8MB L3 cache, 4 Cores, 45W)
Up to 3.80 GHz with Intel® Turbo Boost Technology

Intel® Xeon® E3-1505M v5 with Intel® HD graphics P530 (2.80 GHz, 2133 MHz, 8 MB L3 Cache, 4 Cores, 45W)
Up to 3.70 GHz with Intel® Turbo Boost Technology

Intel® Core™ i7-6820HQ with Intel® HD graphics 530 (2.70 GHz, 2133 MHz, 8 MB L3 Cache, 4 Cores, 45W)
Up to 3.60 GHz with Intel® Turbo Boost Technology

Intel® Core™ i7-6700HQ with Intel® HD graphics 530 (2.60 GHz, 2133 MHz, 6 MB L3 Cache, 4 Cores, 45W)
Up to 3.50 GHz with Intel® Turbo Boost Technology

*Multi-Core™ is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering is not a measurement of higher performance.

Also note that the Intel® Turbo Boost is based on max GHz for a single core.

CHIPSET

Mobile Intel® CM236

Features

INTEL® CORE™ i7 WITH VPRO/XEON® WITH VPRO TECHNOLOGY CAPABLE

Intel® Core™ i7 with vPro™ and XEON® with vPro™ technology is a selectable feature that is available on units configured with select processors, a qualified Intel® Centrino® WLAN module and a preinstalled Windows® operating system. It provides advances in remote manageability, security, energy efficient performance, and wireless connectivity. Intel® Active Management Technology (iAMT) offers built-in manageability and proactive security for networked mobile workstations, even when they are powered off* or when the operating system is inoperable. It can help identify threats before they reach the network, isolate infected systems, and update regardless of their power state.

* Requires a Windows operating system, network hardware and software, connection with a power source, and a direct (non-VPN) corporate network connection which is either cable or wireless LAN.

NOTE: Some functionality of Intel® Core™ i5 with vPro/Core™ i7 with vPro/Xeon® with vPro technology, such as Intel® Active Management technology and Intel® Virtualization technology, requires additional third- party software in order to run. Availability of future "virtual appliances" applications for Intel® Core™ i5 with vPro/Core™ i7 with vPro/XEON® with vPro technology is dependent on third- party software providers. Compatibility with future "virtual appliances" is yet to be determined.

Features

GRAPHICS

Intel Integrated

Intel® HD graphics 530*

Intel® HD graphics P530*

Intel® Iris Pro Graphics P580

Discrete

HP ZBook Studio special edition: NVIDIA® Quadro® M1000M with 4GB dedicated GDDR5 graphics memory
Microsoft DirectX 12 (Shader Model 5.0) and OpenGL 4.4 capable

*HD content required to view HD images.

NOTE: NVIDIA® Quadro® mobile professional graphics support up to four independent displays when using an HP ZBook Dock with Thunderbolt™ 3 (sold separately) or DisplayPort 1.2 hubs with MST.

NVIDIA® Optimus Technology supported

NOTE 1: Color management on the UHD DreamColor panel is not supported while NVIDIA® Optimus Technology is activated.

DisplayPort 1.2 protocol features supported on Thunderbolt™ 3 ports:

- Legacy displays (HDMI, DVI, VGA) may be attached to Thunderbolt™ port with the use of a certified dongle.
- DisplayPort monitors capable of supporting DisplayPort 1.2 may be directly attached to the Thunderbolt™ port to achieve HBR2 with the use a dongle.
- Thunderbolt™ 3 enabled monitors may be directly attached to the Thunderbolt port to achieve HBR2 and MST.
- DisplayPort 1.2 MST feature ("daisy-chain" feature) is supported through Thunderbolt™ 3 port on Thunderbolt™ 3 enabled devices or DisplayPort 1.2 monitors (requires monitor with DisplayPort 1.2 MST capability) with the use of a dongle.
- Up to 2 streams (eight lanes) of DisplayPort 1.2 are supported over a single Thunderbolt™ 3 port. Up to (2) 4K displays 24/30-bit color depth at 60 Hz or (1) 5K display supported over a single Thunderbolt™ 3 port. (Requires Intel® certified Thunderbolt™ cable).
- DisplayPort 1.2 w/MST (Multi-stream Transport): Supports resolutions up to Full 4K, 24/30-bit color depth at 60 Hz, and WUXGA (1920 x1200) monitors, 24/30-bit color depth at 120 Hz.

*Thunderbolt™ 3 is superset port supporting DisplayPort 1.2, USB 3.1 Gen 2, and PCIe Gen 3 devices over the new USB-C™ connector. Install all the latest drivers for your Thunderbolt™ device before connecting the device to the Thunderbolt™ port. Thunderbolt™ cable and Thunderbolt™ device (sold separately) must be compatible with Windows. To determine whether your device is Thunderbolt™ Certified for Windows, see <https://Thunderbolttechnology.net/products>.

Multi-Display Support

Without ZBook Dock with Thunderbolt™ 3:

HP ZBook Studio with hybrid graphics and without the use of the ZBook dock supports up to a maximum of three independent displays. These three displays are the internal panel plus two external displays connected to two of the three following ports: HDMI 1.4, Thunderbolt™ 3, Thunderbolt™ 3. HP ZBook Studio configuration with Intel® integrated graphics and without the use of the ZBook dock supports up to a maximum of three independent displays. These three displays are the internal panel plus two external displays connected to two of the three following ports: HDMI, Thunderbolt™ 3, Thunderbolt™ 3.

With ZBook Dock with Thunderbolt™ 3:

Features

The ZBook Dock with Thunderbolt™ 3 has a Thunderbolt™ 3 port, VGA port, and two DisplayPort 1.2 ports. When used together with the HP ZBook Studio configuration with hybrid graphics, a maximum of 5 independent displays are supported. These five displays are internal panel plus four external displays connected to the ZBook dock's Thunderbolt™ 3, VGA, and two DisplayPort ports. When used together with the HP ZBook Studio configuration with Intel® integrated graphics, a maximum of 3 independent displays are supported.

Without ZBook Dock with Thunderbolt™ 3 (using DP 1.2 MST)

Multi-stream Transport (MST) is a DP 1.2 feature that allows daisy chaining of DP 1.2 monitors (requires built in support of DP 1.2 MST in monitor), or the use of DP 1.2 hubs with MST to achieve 5 active displays without a docking station on configurations with hybrid graphics enabled.

* HP ZBook Dock with Thunderbolt™ 3 sold separately.

DISPLAY

Internal

15.6-inch diagonal LED-backlit FHD UWVA IPS eDP anti-glare + Panel Self Refresh (PSR) (1920 x 1080)
15.6-inch diagonal UHD+ UWVA IPS LED anti-glare (3840x2160)
15.6-inch diagonal UHD UWVA IPS LED anti-glare + Panel Self Refresh (PSR) Dreamcolor (3840x2160)
15.6-inch diagonal Touch LED-backlit FHD UWVA IPS (1920 x 1080)

External

Up to 30-bit (2³⁰) per pixel "Deep Color"
(total of 1,073,741,824 color variations)

NOTE: Resolutions are dependent upon monitor capability, and resolution and color depth settings.

Features

STORAGE AND DRIVES

HP Z Turbo Drives (NVMe PCIe SSD)

256GB NVMe PCIe SSD
512 GB (NVMe) PCIe SSD
1 TB NVMe PCIe SSD

M.2 SATA SSD

128 GB SATA 6 Gb/sec SATA SSD (Available in 1H16)

M.2 SATA SED SSD

256 GB SATA Self Encrypting Drive (SED)
512 GB SATA Self Encrypting Drive (SED) (Available in 1H16)

*For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows® 8.1/10) is reserved for system recovery software.

DRIVE CONTROLLERS

| | |
|---------------------------|-----------------|
| M.2 Storage Slots (SATA): | SATA-3 for SSD |
| HP Z Turbo Drive: | PCIe NVMe SSD |
| RAID: | 0, 1 supported* |

NOTE: Raid 0, 1 supported only on SATA drives.

MEMORY

Standard

32GB DDR4 1.2V ECC or Non-ECC SDRAM (Transfer rates up to 2133MT/s)
Two SODIMM slots supporting dual-channel memory
4 GB, 8GB and 16 GB SODIMMs (for Intel® Core™ Processors)
8GB and 16 GB ECC SODIMMs (for Intel® XEON® Processors)

Maximum

Upgradeable to 32768 MB with optional 16384 MB SODIMMs in 2 slots

Dual-channel

Maximized dual-channel performance requires SODIMMs of the same size and speed in both memory channels.

NOTE 1: Non-ECC memory only available with Intel® Core™ processors. ECC memory only available with Intel® Xeon® processors.

NOTE 2: Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed. Maximum memory capacities assume Windows® 64-bit operating systems or LINUX®.

Features

NETWORKING/COMMUNICATIONS

Communications

Integrated Intel® I219-LM Gigabit* Network Connection

Wireless

Secure, integrated wireless LAN options featuring support for the latest industry standards. Integrated Bluetooth® is also available (factory configurable only) and is combined with the supported wireless LAN feature.

802.11 Wireless LAN options

Intel® Dual Band Wireless-AC 8260 802.11 AC/a/b/g/n (2x2) WiFi + Bluetooth® 4.2 Combo Adaptor** (vPro)

Intel® Dual Band Wireless-AC 8260 802.11 AC/a/b/g/n (2x2) WiFi + Bluetooth® 4.2 Combo Adaptor** (non-vPro)

* The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

** Wireless cards are optional or add-on features and requires separately purchased wireless access point and internet service. Availability of public wireless access points limited. The specifications for the 802.11ac WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ac WLAN devices.

AUDIO/MULTIMEDIA

Audio

Bang and Olufsen HD audio Integrated stereo speakers

Integrated microphone (dual-microphone array when equipped with optional webcam)

Button for volume mute; function keys for volume up and down

Combo microphone-in / stereo headphone-out jack

Webcam

Optional 720p HD* webcam

- HD format (widescreen)
- Supports videoconferencing and still image capture
- High quality fixed focus lens
- Video capture at various resolutions up to 1280x720 resolution (720p) and up to 30fps
- M-JPEG compression supports higher frame rates for video capture and videoconferencing
- Improved low light sensitivity
- Improved dynamic range

*HD content required to view HD images.

Features

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard

Backlit keyboard with Function key control to toggle backlit brightness setting - off/full/half brightness
The HP spill-resistant keyboard is designed using a thin layer of Mylar film under the keyboard and a drain system that funnels fluid through a hole in the bottom of the notebook. This helps reduce the risk of damage to sensitive components underneath. The 85-key compatible keyboard features a full-pitch key layout with desktop keyboard features, such as editing keys, both left and right control and alt keys, function keys, and 18.7 x 18.4 mm key pitch (center-to-center spacing). U.S. and International key layouts are available. Other features include hot keys for instant access to power conservation and brightness.

Pointing Devices

Large clickpad with On/Off button, two-way scroll, gestures, two integrated buttons within clickpad surface
Image sensor clickpad for enhanced performance and improved precision on scroll and gesture.

Buttons and Function Keys

Separate launch buttons provide easy access to the following features: wireless on/off, volume mute. Function keys provide control of the following features: standby mode, external display, volume down, volume up, and display brightness.

Features

SOFTWARE AND SECURITY

Preinstalled Software with Windows® Operating System

BIOS

HP BIOSphere¹

HP Sure Start with Dynamic Protection

HP DriveLock¹⁸ | HP Automatic DriveLock

HP BIOS Protection²

BIOS Update via Network

Master Boot Record Security

Power On Authentication

Pre-Boot Security

HP SpareKey¹⁷

Secure Erase³

Hybrid Boot

Measure Boot

Secure Boot

Absolute Persistence Module⁴

Pre-boot Authentication

Multi Media

Cyberlink Power DVD, BD (supports file play back)

Cyberlink YouCam BE (Windows® 7 only)

Communication

HP GPS and Location (Windows® 7 only)⁵

HP Connection Manager with support for HP Mobile Connect (Windows® 7 only)⁶

HP Mobile Connect Pro (Windows® 8.1 and Windows® 10 only)⁶

Intel® Wireless Display (WiDi) Software for Windows®⁷

Native Miracast Support⁸

HP Value Add Software

HP 3D DriveGuard

HP ePrint Driver⁹

HP Hotkey

HP Recovery Manager¹⁶

HP Recovery Disc Creator

HP Registration App (Windows® 8.1 only)

HP Support Assistant

HP Noise Reduction Software

HP Performance Advisor

HP Remote Graphics Software

HP Velocity

Features

3rd Party

Foxit PhantomPDF Express for HP

Microsoft Products

Buy Office

Bing Search

Skype¹⁰

Manageability

HP Driver Packs¹¹

HP SoftPaq Download Manager (SDM)

HP System Software Manager (SSM)¹¹

HP BIOS Config Utility (BCU)¹¹

HP Client Catalog¹¹

HP CIK for Microsoft SCCM¹¹

HP Image Assistant¹¹

LANDESK Management¹²

For more information on HP Client Management Solutions refer to: <http://www.hp.com/go/clientmanagement>.

Client Security Software

HP Client Security

- HP Security Manager (including Credential Manager and Password Manager)
- HP Drive Lock
- HP Fingerprint Sensor
- HP Password Manager
- Absolute Persistence Module
- Power On Authentication

Microsoft Security Essentials¹⁴

Microsoft Defender ¹⁴

Standard

Trusted Platform Module (TPM) 1.2 Embedded Security Chip (Common Criteria EAL4+ Certified) Field upgradeable to TPM 2.0¹⁵

HP Fingerprint Reader

For more information on HP Client Security Software Suite, refer to <http://www.hp.com/go/clientsecurity>.

1 Available only on business PCs with HP BIOS.

2 May require a manual recovery step if all copies of BIOS are compromised or deleted

3 For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88.

4 Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription.

Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit:

<http://www.absolute.com/company/legal/agreements/> computrace-agreement. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service,

Features

customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.

5 GPS access requires an unobstructed path to multiple satellites. Performance may be affected if/when used inside of buildings, bridges or heavily congested metropolitan areas. Requires separately purchased GPS navigation software available from multiple GPS applications.

6 HP Mobile Connect Pro is only available on preconfigured devices with WWAN. For geographic availability refer to <http://www.hp.com/go/mobileconnect>

7 Integrated Intel® Wi-Di feature is available on select configurations only and requires separately purchased projector, TV or computer monitor with an integrated or external Wi-Di receiver. External Wi-Di receivers connect to the projector, TV or computer monitor via a standard HDMI cable, also sold separately.

8 Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming media players that also support Miracast. You can use Miracast to share what you're doing on your PC and present a slide show. For more information:

<http://Windows®.microsoft.com/en-us/Windows®-8/project-wireless-screen-miracast>

9 Requires an Internet connection to HP web-enabled printer and HP ePrint account registration (for a list of eligible printers, supported documents and image types and other HP ePrint details, see

<http://www.hp.com/go/eprintcenter>). Requires optional broadband module. Broadband use requires separately purchased service contract. Check with service provider for coverage and availability in your area. Separately purchased data plans or usage fees may apply. Print times and connection speeds may vary.

10 Skype is not offered in China.

11 Not preinstalled, however available for download at <http://www.hp.com/go/clientmanagement>

12 Subscription required.

14 Opt in and internet connection required for updates.

15 This product ships with TPM 1.2 with option to upgrade to TPM 2.0. Upgrade utility is expected to be available by the end of 2015 via HP Customer Support.

16 Models shipped with Windows® 7 include HP Recovery Manager. HP Recovery Manager enables fast recovery of the factory preinstalled image if the system becomes corrupted or if important system files are accidentally deleted. Up to 36 GB (for Windows® 7) of system and up to 36 GB (for Windows® 10) disk is reserved for system recovery software.

17 Requires initial user setup

18 DriveLock feature only supported with SATA drives. DriveLock feature not supported on HP Z Turbo Drive PCIe SSDs.

Workstation ISV Certifications

See the latest list of certifications at: <http://www.hp.com/go/isv>

HP Remote Graphics Software

The remote desktop solution for serious workstation users and their most demanding applications.

Download at: <http://www.hp.com/go/RGS>

HP Performance Advisor

HP Performance Advisor enables optimal configuration of HP Mobile Workstations delivering stability and best performance. HP Performance Advisor will guide your system setup allowing a "custom" configuration that best matches the workstation to user requirements.

Download at: <http://www.hp.com/go/performanceadvisor>

Security

See Software section above.

Other Standard Security Features

One-Step Logon

Security lock slot

Support for Intel® AT

Optional Security Features

HP Fingerprint Sensor (optional)

Absolute Data Protect* with GPS Tracking - Subscription based security solution providing the ability to track, initiate physical recovery, conduct asset management, and perform remote data delete by utilizing GPS technology. GPS functionality

Features

requires HP Mobile Broadband Module.

* The Absolute Data Protect is shipped turned off, and must be activated by customers when they purchase a subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S.

Features

HP CENTRAL MANAGEMENT

HP offers a variety of scalable hardware, software, and BIOS-based security features to help you defend your organization against viruses and other threats. These integrated security features safeguard what matters to you the most - your data, device and identity. Now, be confident your fleet of devices is protected in multiple layers of HP Client Security protection.

HP BIOS Protection keeps you up and running with enhanced protection against virus attacks and other threats. And if the BIOS is accidentally compromised, the auto recovery feature automatically restores it to its fully functional state.

HP Sure Start detects and negates a BIOS attack with automatic recovery of the BIOS even when the installation is accidentally compromised (i.e. power outage). When HP Sure Start heals the BIOS an event log is generated that an IT administrator can retrieve so the business is aware of a BIOS attack. Golden copy of BIOS is stored in protected nonvolatile memory providing redundant, hardware-based protection against a new generation of attacks. This helps to future-proof your technology and business.

An optional fingerprint reader to help keep your identity secure. The security cable slot helps keep your notebook physically secure.

You can even permanently destroy data on your hard drive in preparation for your system disposal or redeployment with Secure Erase.

Features

POWER

Power Supply

External HP 150W Slim Smart AC adapter
(153 x 66 x 22 mm)

Primary Battery

HP Long Life 4-cell Prismatic Battery (64 WHr) *

Battery Life

Battery life up to 9 hours and 30 minutes**

NOTE: Battery is internal and no replaceable by the costumer

System Standby Time

Up to TBD weeks***

* Available with 3-year limited warranty only

**Windows® 10 MM14 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See <http://www.bapco.com> for additional details.

***Standby life will vary depending on various factors including battery, Memory, CPU, EC and LAN chip. The maximum capacity of the battery will naturally decrease with time and usage.

Power Conservation

NVIDIA® Optimus

Hibernation

Standby

ACPI compliance

ENVIRONMENTAL

US ENERGY STAR®

IT ECO declaration

EPEAT®

WEIGHTS & DIMENSIONS

Weight

Starting at 4.4 lb (2.00 kg)

Dimensions (w x d x h)

14.76 in x 10.04 in x 0.71 in

375 mm x 255 mm x 18 mm

NOTE: Height varies depending upon where on the notebook the measurement is made. Weight varies by configuration and components. Weight includes Quad Core™ CPU, FHD, Intel® HD graphics, 4GBx1 SODIMM, HP Z Turbo Drive, wLAN/BT, FPR, 4-cell battery.

Features

PORTS/SLOTS

Ports

Left side:

- (1) RJ-45 (Ethernet)
- (1) USB 3.0
- (1) USB 3.0 Charging Port
- (1) Security lock slot

Right side:

- (1) Power Connector
- (2) Thunderbolt™ 3 (supporting DP 1.2, USB 3.1 Gen2, PCIe Gen 3 devices)
- (1) HDMI 1.4
- (1) USB 3.0
- (1) Stereo microphone in / headphone-out combo jack

Thunderbolt™ 3

Thunderbolt™3 ports supports DisplayPort 1.2, USB 3.1 Gen 2, and PCIe Gen 3 devices over the new USB-C port connector. The port is compatible with existing DisplayPort displays, devices, and cables. Install all the latest drivers for your Thunderbolt™ device before connecting the device to the Thunderbolt™ port. Thunderbolt™ cable and Thunderbolt™ device (sold separately) must be compatible with Windows®. To determine whether your device is Thunderbolt™ Certified for Windows®, see <https://Thunderbolttechnology.net/products>.

Digital Media Slots

- (1) SD UHS-II Flash Media slot – Supports next generation SD (Secure Digital), backward compatible to SDHC, SDXC)

SERVICE AND SUPPORT

Limited 3-year or 1-year limited warranty options available, depending on country. Batteries have a default one year limited warranty except for Long Life batteries which will have same 1-year or 3-year limited warranty as the platform. Optional¹ HP Care Pack Services are extended service contracts which go beyond your standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at <http://www.hp.com/go/cpc>.

Sold separately or as an optional feature.

1. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product. Consult your local HP Customer Support Center for details.

Technical Specifications

SYSTEM UNIT

| | | | |
|--|---|--|--|
| Stand-Alone Power Requirements (AC Power) | Nominal Operating Voltage | 19.5 V | |
| | Average Operating Power | DreamColor Without DreamColor | 25 W (Windows® 7 64-bit) 16.8 W (Windows® 7 64-bit) |
| | Max Operating Power | < 200 W | |
| Temperature | Operating | 32° to 95° F (0° to 35° C) | |
| | Non-operating | -4° to 140° F (-20° to 60° C) | |
| Relative Humidity | Operating | 10% to 90%, non-condensing | |
| | Non-operating | 5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature | |
| Shock | Operating | 40 G, 2 ms, half-sine | |
| | Non-operating | 200 G, 2 ms, half-sine | |
| Random Vibration | Operating | 0.75 grms | |
| | Non-operating | 1.50 grms | |
| Altitude (unpressurized) | Operating | -50 to 10,000 ft (-15.24 to 3,048 m) | |
| | Non-operating | -50 to 40,000 ft (-15.24 to 12,192 m) | |
| Industry Standard Certifications | UL | Yes | |
| | CSA | Yes | |
| | FCC Compliance | Yes | |
| | ENERGY STAR® | Select models* | |
| | EPEAT® | Gold ** | |
| | ICES | Planned | |
| | Australia / NZ A-Tick Compliance | Planned | |
| | CCC | Planned | |
| | Japan VCCI Compliance | Planned | |
| | KC | Planned | |
| | BSMI | Planned | |
| | CE Marking Compliance | Planned | |
| MIL STD 810G | Planned*** | | |

* Configurations of the HP ZBook Studio that are ENERGY STAR® qualified are identified as HP ZBook Studio G3 ENERGY STAR® on HP websites and on <http://www.energystar.gov>.

** EPEAT® registered where applicable. EPEAT registration varies by country. See <http://www.epeat.net> for registration status by country.

*** MIL STD 810G testing is pending and is not intended to demonstrate fitness for U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Damage under the MIL STD test conditions or any accidental damage requires an optional HP Accidental Damage Protection Care Pack.

For accessibility information on HP products, please visit: <http://www.hp.com/accessibility>.

DISPLAYS

| | | |
|--|----------------------------|----------------------------------|
| 15.6" diagonal LED-backlit FHD UWVA IPS | Active Area (W x H) | 13.54 x 7.59 in (34.4 x 19.4 cm) |
| | Dimensions (W x H) | 15.6 in (34.4 x 19.4 cm) |

Technical Specifications

| | | |
|--|--------------------------|--|
| eDP anti-glare + Panel Self Refresh (PSR) (1920 x 1080) | Weight | 360 g (max) |
| | Surface Treatment | Anti-glare |
| | Contrast Ratio | 600:1 (typical) |
| | Refresh Rate | 60 Hz |
| | Brightness | 300 nit typical |
| | Pixel Resolution | Format 1920 x 1080 (FHD) |
| | | Configuration RGB Stripe |
| | Backlight | LED |
| | PPI | 141 |
| | Viewing Angle | 85/85/85/85 (Left/Right/Down/Up) (typical) |

| | | |
|--|--|----------------------------------|
| 15.6-inch UHD UWVA IPS LED anti-glare (3840 x 2160) | Active Area (W x H) | 13.54 x 7.59 in (34.4 x 19.4 cm) |
| | Dimensions (W x H) | 15.6 in (39.6 cm) |
| | Weight | 380 g (max) |
| | Surface Treatment | Anti-glare |
| | Contrast Ratio | 400:1 (typical) |
| | Refresh Rate | 60 Hz |
| | Brightness | 270 nit typical |
| | Pixel Resolution | Format 1920 x 1080 (FHD) |
| | | Configuration RGB Stripe |
| | Backlight | LED |
| PPI | 141 | |
| Viewing Angle | 85/85/85/85 (Left/Right/Down/Up) (typical) | |

| | | |
|--|--|----------------------------------|
| 15.6-inch UHD+ UWVA IPS LED anti-glare + Panel Self Refresh (PSR) Dreamcolor* (3840x2160) | Dimensions (W x H) | 13.62 x 7.59 in (34.6 x 19.4 cm) |
| | Diagonal Size | 15.6 in (39.6 cm) |
| | Weight | 345 g (max) |
| | Surface Treatment | Anti-glare |
| | Contrast Ratio | 1000:1 (typ) |
| | Refresh Rate | 60 Hz |
| | Brightness | 270 nit typical |
| | Pixel Resolution | Format 3840x2160 |
| | | Configuration RGB Stripe |
| | Backlight | LED |
| PPI | 282 | |
| Viewing Angle | 85/85/85/85 (Left/Right/Down/Up) (typical) | |

* UHD+ Dreamcolor to be available in 1H16

| | | |
|---------------------------------|---------------------------|------------------------------------|
| 15.6-inch FHD TOUCH UWVA | Dimensions (W x H) | 13.62 x 7.59 in (36 x 22.4 cm max) |
| | Diagonal Size | 15.6 in (39.6 cm) |

Technical Specifications

| | | | | |
|--------------------------------|--------------------------|--|-------------------|--|
| IPS LED (1920x1080) | Weight | 345 g (max) | | |
| | Surface Treatment | Anti-glare | | |
| | Contrast Ratio | 600:1 (typ) | | |
| | Refresh Rate | 60 Hz | | |
| | Brightness | 300 nit typ | | |
| | Pixel Resolution | Format | 1920 x 1080 (FHD) | |
| | | Configuration | RGB Stripe | |
| | Backlight | LED | | |
| | PPI | 142 | | |
| | Viewing Angle | 85/85/85/85 (Left/Right/Down/Up) (typical) | | |

STORAGE AND DRIVES

Internal Storage

| | | | | |
|--|----------------------------------|--|---------------------------------|--|
| 128 GB M2 2280 SATA-3 TLC Solid State Drive | Drive Weight | 0.019 lb (8.5 g)-0.022 lb (10 g) | | |
| | Capacity | 128 GB | | |
| | Height | 0.09 in (2.23 mm)- 0.14 in (3.58 mm) | | |
| | Width | 0.87 in (22 mm) | | |
| | Interface | ATA-8, SATA 3.0 | | |
| | Performance | Maximum Sequential Read | Maximum Sequential Write | |
| | | Up to 540 MB/s | Up to 300 MB/s | |
| | Logical Blocks | 250,069,680 | | |
| | Operating Temperature | 32° to 158°F (0° to 70°C) [ambient temp] | | |
| Features | ATA Security, DIPM; TRIM; DEVSLP | | | |

| | | | | |
|---|--|--------------------------------|--|--|
| 512 GB M2 2280 SATA-3 Self-Encrypting Drive (Opal 2) MLC Solid State Drive | Drive Weight | 0.02 lb (<10 g) | | |
| | Capacity | 512GB | | |
| | Height | 0.09 in (2.3mm) | | |
| | Width | 0.87 in (22 mm) | | |
| | Interface | ATA-8, SATA 3.0 | | |
| | Performance | Maximum Sequential Read | | |
| | | Up to 540 MB/s | | |
| Logical Blocks | 1,000,215,216 | | | |
| Operating Temperature | 32° to 158°F (0° to 70°C) [ambient temp] | | | |

| | | | |
|---|---------------------|--------------------------------------|--|
| 256 GB M2 2280 SATA-3 Self-Encrypting Drive (Opal 2) MLC Solid State Drive | Drive Weight | 0.02 lb (<10 g) | |
| | Capacity | 256 GB | |
| | Height | 0.14 in (3.58 mm)- 0.09 in (2.23 mm) | |
| | Width | 0.87 in (22 mm) | |
| | Interface | ATA-8, SATA 3.0 | |

Technical Specifications

| | | |
|------------------------------|--|---------------------------------|
| Performance | Maximum Sequential Read | Maximum Sequential Write |
| | Up to 540 MB/s | UP to 460 MB/s |
| Logical Blocks | 500,118,192 | |
| Operating Temperature | 32° to 158°F (0° to 70°C) [ambient temp] | |

HP Z Turbo Drive 1TB, M.2 NVMe PCIe Solid State Drive

| | | |
|------------------------------|--|---------------------------------|
| Drive Weight | 0.022 lb (<10 g) | |
| Capacity | 1TYB | |
| Height | 0.14 in (3.7 mm) | |
| Width | 0.87 in (22 mm) | |
| Generation | XG4 NVMe | |
| NAND Type | MLC | |
| Form-Factor (I/O) | M.2 2280 | |
| Interface | PCIe GEN3X4 | |
| Performance | Maximum Sequential Read | Maximum Sequential Write |
| | Up to 2400MB/s | Up to 1500MB/s |
| Logical Blocks | 2,000,409,264 | |
| Operating Temperature | 32° to 158°F (0° to 70°C) [ambient temp] | |
| Features | ATA Security, L1.2 | |

HP Z Turbo Drive 512 GB, M.2 NVMe PCIe Solid State Drive

| | | |
|------------------------------|--|---------------------------------|
| Drive Weight | 0.022 lb. (10 g) | |
| Capacity | 512 GB | |
| Height | 0.14 in (3.7 mm) | |
| Width | 0.87 in (22 mm) | |
| Generation | SM951 NVMe | |
| NAND Type | MLC | |
| Form-Factor (I/O) | M.2 2280 | |
| Interface | PCIe GEN3X4 | |
| Performance | Maximum Sequential Read | Maximum Sequential Write |
| | Up to 2260MB/s | Up to 1600MB/s |
| Logical Blocks | 1,000,215,216 | |
| Operating Temperature | 32° to 158°F (0° to 70°C) [ambient temp] | |
| Features | ATA Security; TRIM; L1.2 | |

* For hard drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 16 GB (for Windows® 7) of system and up to 30 GB (for Windows® 8) disk is reserved for system recovery software.

| | |
|---------------------|-------------------|
| Drive Weight | 0.022 lb. (<10 g) |
| Capacity | 256 GB |

Technical Specifications

| | | | |
|---|------------------------------|--|---------------------------------|
| HP Z Turbo Drive 256 GB, M.2 NVMe PCIe Solid State Drive | Height | 0.09 in (2.3 mm) | |
| | Width | 0.87 in (22.1 mm) | |
| | Generation | SM951 NVMe | |
| | NAND Type | MLC | |
| | Form-Factor (I/O) | M.2 2280 | |
| | Interface | PCIe GEN3X4 | |
| | Performance | Maximum Sequential Read | Maximum Sequential Write |
| | | Up to 2260MB/s | Up to 1260 MB/s |
| | Logical Blocks | 500,118,192 | |
| | Operating Temperature | 32° to 158°F (0° to 70°C) [ambient temp] | |
| Features | ATA Security; TRIM; L1.2 | | |

Technical Specifications – Security

SECURITY

| | | |
|------------------------------|------------------------------------|---|
| HP Fingerprint Sensor | Mobile Voltage Operation | 3.0V-3.6V Single Supply |
| | Operating Temperature | 14° - 167°F (-10° - 75°C) |
| | Current consumption image | 36mA |
| | Low latency wait for finger | 950 uA |
| | Capture rate | 3000 lines/sec |
| | ESD Resistance | IEC 6100-4-2 4B (+/-15KV) |
| | Detection Matrix | 200*1 (plus another secondary line); 508 dpi, sensor area 12*3 mm |
| | | |

Technical Specifications – Networking/Communications

NETWORKING/COMMUNICATIONS

| | | |
|---|-------------------------------|--|
| Intel® I219-LM Gigabit Network Connection | Ethernet Features | <p>10 Mbit/s operation (10BASE-T; IEEE 802.3; IEEE 802.3 clauses 13-14) 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 802.3. Clauses 40) IEEE 802.3u Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s IEEE 802.1p QoS (Quality of Service) Support IEEE 802.1q VLAN support IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable) IEEE 802.3az EEE(Energy Efficient Ethernet) IEEE 802.1as/1588 conformance Jumbo Frame 9K Auto MDI/MDIX Crossover cable detection</p> |
| | Power Management | <p>ACPI compliant - multiple power modes Energy Detect Low Power Mode(Green Ethernet)</p> |
| | Performance Features | <p>TCP/IP/UDP Checksum Offload (configurable) Protocol Offload(ARP & NS) Large send offload and Giant send offload Receiving Side Scaling MACSec Offload (802.3ae) Intel® vPro iSCSI Boot RSS (Receive Side Scaling) Ultra Low Power</p> |
| | Manageability | <p>Wake-on-LAN from standby and hibernation (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only) PXE 2.1 Remote Boot Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30)) Comprehensive diagnostic and configuration software suite Virtual Cable Doctor for Ethernet cable status</p> |
| | Interface | <p>PCI Express 1.1 x1 to fully support ASPM L0s/L1 and CLKREQ. NOTE: Intel® I219-LM Gigabit interface is not PCIe compliant. It operates at half of PCIe specification V1.1 (2.5GT/S) speed.</p> |
| | NIC Device Driver Name | <p>Intel® Ethernet Network Connection I219-LM</p> |
| Intel® Dual Band Wireless-N 8260AC 802.11 AC/a/b/g/n (2x2) WiFi + Bluetooth® 4.2 Combo Adaptor* (vPro) | Wireless LAN Standards | <p>IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac</p> |
| | Interoperability | <p>Wi-Fi certified</p> |
| | Frequency Band | <p>802.11b/g/n 2.402 - 2.482 GHz</p> <p>Note: The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.</p> <p>802.11a/n 4.9 - 4.95 GHz (Japan) 5.15 - 5.25 GHz</p> |

Technical Specifications – Networking/Communications

5.25 - 5.35 GHz
5.47 - 5.725 GHz
5.825 - 5.850 GHz

Note: Indonesia no support this band)

Data Rates

- 802.11b: 1, 2, 5.5, 11 Mbps
- 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
- 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
- 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)
- 802.11ac : MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz)

Modulation

Direct Sequence Spread Spectrum
BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

Security¹

- IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only
- AES-CCMP: 128 bit in hardware
- 802.1x authentication
- WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.
- WPA2 certification
- IEEE 802.11i
- Cisco Certified Extensions, all versions through CCX4 and CCX Lite
- WAPI

Network Architecture Models

Ad-hoc (Peer to Peer)
Infrastructure (Access Point Required)

Roaming

IEEE 802.11 compliant roaming between band Access Points

Output Power²

- 802.11b : +16dBm minimum
- 802.11g : +14dBm minimum
- 802.11a : +14dBm minimum
- 802.11n HT20(2.4GHz) : +14dBm minimum
- 802.11n HT40(2.4GHz) : +12dBm minimum
- 802.11n HT20(5GHz) : +14dBm minimum
- 802.11n HT40(5GHz) : +12dBm minimum

Power Consumption

Transmit: 2.0 Watts (max)
Receive: 1.6 Watts (max)
Idle mode(PSP): 180 mW (WLAN associated)
Idle mode: 50 mW (WLAN unassociated)
Connect standby: 10mW (WLAN+BT)
Radio disabled: 5 mW

Power Management

ACPI and PCI Express compliant power management
802.11 compliant power saving mode

Receiver Sensitivity³

802.11b, 1Mbps : -94dBm maximum
802.11b, 11Mbps : -86dBm maximum
802.11g, 6Mbps : -88dBm maximum
802.11g, 54Mbps : -74dBm maximum
802.11a, 6Mbps : -88dBm maximum
802.11a, 54Mbps : -74dBm maximum
802.11n, MCS07 : -69dBm maximum
802.11n, MCS15 : -66dBm maximum

Technical Specifications – Networking/Communications

| | |
|--------------------------|--|
| | 802.11ac, 1SS, MCS-0 : -86dBm maximum 802.11ac, 1SS, MCS-9 : -61dBm maximum 802.11ac, 2SS, MCS-0 : -83dBm maximum 802.11ac, 2SS, MCS-9 : -58dBm maximum |
| Antenna Type | High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth® communications |
| Form Factor | PCI-Express M.2 MiniCard |
| Dimensions | Type 2230 : 2.3 x 22.0 x 30.0 mm Or Type 1630 : 2.3 x 16.0 x 30.0 mm |
| Weight | Type 2230 : 2.8g Or Type 1630 : 2g |
| Operating Voltage | 3.3v +/- 9% |
| Temperature | Operating 14° to 158° F (-10° to 70° C) Non-operating -40° to 176° F (-40° to 80° C) |
| Humidity | Operating 10% to 90% (non-condensing) Non-operating 5% to 95% (non-condensing) |
| Altitude | Operating 0 to 10,000 ft (3,048 m) Non-operating 0 to 50,000 ft (15,240 m) |
| LED Activity | LED Amber - Radio OFF; LED White - Radio ON |

1. Check latest software/driver release for updates on supported security features.
2. Maximum output power may vary by country according to local regulations.
3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CCK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP Integrated Module with Bluetooth® 4.0/4.1/4.2 Wireless Technology

| | |
|-------------------------------------|--|
| Bluetooth® Specification | 4.0/4.1/4.2 Compliant |
| Dimensions | 1.18 x 0.26 x 0.13 in (30 x 6.5 x 3.25 mm)) |
| Frequency Band | 2402 to 2480 MHz |
| Number of Available Channels | Legacy: 0-79 (1 MHz/CH) BLE: 0-39 (2 MHz/CH) |
| Data Rates and Throughput | Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps BLE : 1 Mbps data rate; throughput up to 0.2 Mbps Legacy : Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy : Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5) |
| Transmit Power | The Bluetooth® component shall operate as a Class II Bluetooth® device with a maximum transmit power of + 4 dBm for BR and EDR. |
| Receiver Sensitivity | |

| Modulation | 0.01% BER | 0.001% BER |
|------------|-----------|------------|
| GFSK | -80 dBm | -70 dBm |
| π/4-DQPSK | -80 dBm | -70 dBm |
| 8DPSK | -80 dBm | -70 dBm |

Technical Specifications – Networking/Communications

| | |
|---|---|
| Power Consumption | Peak (Tx) 330 mW Peak (Rx) 230 mW Selective suspend 17 mW |
| Range | Legacy Up to 33 ft (10 m) BLE Up to 99 ft (30 m) |
| Electrical Interface | USB 2.0 compliant |
| Bluetooth® Software Supported | Microsoft Windows® Bluetooth® Software |
| Link Topology | Point to Point, Multipoint Pico Nets up to 7 slaves |
| Security | Full support of Bluetooth® Security Provisions |
| Power Management | Microsoft Windows® ACPI, and USB Bus Support Self-configurable to optimize power conservation in all operating modes, including Standby, Hold, Park, and Sniff |
| Certifications | All necessary regulatory approvals for supported countries, including: FCC (47 CFR) Part 15C, Section 15.247 & 15.249 ETS 300 328, ETS 300 826 Low Voltage Directive IEC950 UL, CSA, and CE Mark |
| Bluetooth® Profiles Supported | Serial Port Profile (SPP) ¹ Service Discovery Application Profile (SDAP) Dial-Up Networking (DUN) ^{1,2} Generic Object Exchange Profile (GOEP) ^{1,2} Object Push Profile (OPP) ^{1,2} Hard Copy Cable Replacement (HCRP) ^{1,2} Personal Area Networking Profile (PAN) ^{1,2} Human Interface Device Profile (HID) ^{1,2} Advanced Audio Distribution Profile (A2DP) Audio Video Remote Control Profile (AVRCP) |
| Bluetooth® V4.1/V4.2 support feature | V4.1: ESR5/6/7 compliant V4.2: ESR8 compliant, LE Secure Connection – Basic. 1. Indicates the profile is supported by Microsoft Windows® XP SP2 2. Indicates the profile is part of Windows® Vista * Wireless access point and internet service required. Availability of public wireless access points limited. |

Technical Specifications – Networking/Communications

**Intel® Dual Band
Wireless-N 8260AC
802.11 AC/a/b/g/n (2x2)
WiFi + Bluetooth® 4.0
Combo Adaptor* (non-
vPro)**

Wireless LAN Standards IEEE 802.11a
IEEE 802.11b
IEEE 802.11g
IEEE 802.11n
IEEE 802.11ac

Interoperability Wi-Fi certified

Frequency Band 802.11b/g/n 2.402 - 2.482 GHz

Note:

The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

802.11a/n 4.9 - 4.95 GHz (Japan)
5.15 - 5.25 GHz
5.25 - 5.35 GHz
5.47 - 5.725 GHz
5.825 - 5.850 GHz

Note: No support for this band in Indonesia.

Data Rates

- 802.11b: 1, 2, 5.5, 11 Mbps
- 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
- 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
- 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)
- 802.11ac : MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz)

Modulation Direct Sequence Spread Spectrum
BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

Security¹

- IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only
- AES-CCMP: 128 bit in hardware
- 802.1x authentication
- WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.
- WPA2 certification
- IEEE 802.11i
- Cisco Certified Extensions, all versions through CCX4 and CCX Lite
- WAPI

Network Architecture Models Ad-hoc (Peer to Peer)
Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between band Access Points

Output Power²

- 802.11b : +16dBm minimum
- 802.11g : +14dBm minimum
- 802.11a : +14dBm minimum
- 802.11n HT20(2.4GHz) : +14dBm minimum
- 802.11n HT40(2.4GHz) : +12dBm minimum
- 802.11n HT20(5GHz) : +14dBm minimum
- 802.11n HT40(5GHz) : +12dBm minimum

Technical Specifications – Networking/Communications

| | |
|---|---|
| Power Consumption | Transmit: 2.0 Watts (max) Receive: 1.6 Watts (max) Idle mode(PSP): 180 mW (WLAN associated) Idle mode: 50 mW (WLAN unassociated) Connect standby: 10mW (WLAN+BT) Radio disabled: 5 mW |
| Power Management | ACPI and PCI Express compliant power management 802.11 compliant power saving mode |
| Receiver Sensitivity³ | 802.11b, 1Mbps : -94dBm maximum 802.11b, 11Mbps : -86dBm maximum 802.11g, 6Mbps : -88dBm maximum 802.11g, 54Mbps : -74dBm maximum 802.11a, 6Mbps : -88dBm maximum 802.11a, 54Mbps : -74dBm maximum 802.11n, MCS07 : -69dBm maximum 802.11n, MCS15 : -66dBm maximum 802.11ac, 1SS, MCS-0 : -86dBm maximum 802.11ac, 1SS, MCS-9 : -61dBm maximum 802.11ac, 2SS, MCS-0 : -83dBm maximum 802.11ac, 2SS, MCS-9 : -58dBm maximum |
| Antenna Type | High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth® communications |
| Form Factor | PCI-Express M.2 MiniCard |
| Dimensions | Type 2230 : 2.3 x 22.0 x 30.0 mm Or Type 1630 : 2.3 x 16.0 x 30.0 mm |
| Weight | Type 2230 : 2.8g Or Type 1630 : 2g |
| Operating Voltage | 3.3v +/- 9% |
| Temperature | Operating 14° to 158° F (-10° to 70° C) Non-operating -40° to 176° F (-40° to 80° C) |
| Humidity | Operating 10% to 90% (non-condensing) Non-operating 5% to 95% (non-condensing) |
| Altitude | Operating 0 to 10,000 ft (3,048 m) Non-operating 0 to 50,000 ft (15,240 m) |
| LED Activity | LED Amber - Radio OFF; LED White - Radio ON |

1. Check latest software/driver release for updates on supported security features.
2. Maximum output power may vary by country according to local regulations.
3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CCK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP Integrated Module with Bluetooth® 4.0/4.1/4.2 Wireless Technology

| | |
|-------------------------------------|---|
| Bluetooth® Specification | 4.0/4.1/4.2 Compliant |
| Dimensions | 1.18 x 0.26 x 0.13 in (30 x 6.5 x 3.25 mm)) |
| Frequency Band | 2402 to 2480 MHz |
| Number of Available Channels | Legacy: 0-79 (1 MHz/CH) BLE: 0-39 (2 MHz/CH) |
| Data Rates and Throughput | Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps |

Technical Specifications – Networking/Communications

BLE : 1 Mbps data rate; throughput up to 0.2 Mbps
 Legacy : Synchronous Connection Oriented links up to 3, 64 kbps, voice channels

Legacy : Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power

The Bluetooth® component shall operate as a Class II Bluetooth® device with a maximum transmit power of + 4 dBm for BR and EDR.

Receiver Sensitivity

| Modulation | 0.01% BER | 0.001% BER |
|------------|-----------|------------|
| GFSK | -80 dBm | -70 dBm |
| π/4-DQPSK | -80 dBm | -70 dBm |
| 8DPSK | -80 dBm | -70 dBm |

Power Consumption

Peak (Tx) 330 mW
 Peak (Rx) 230 mW
 Selective suspend 17 mW

Range

Legacy Up to 33 ft (10 m)
 BLE Up to 99 ft (30 m)

Electrical Interface

USB 2.0 compliant

Bluetooth® Software Supported

Microsoft Windows® Bluetooth® Software

Link Topology

Point to Point, Multipoint Pico Nets up to 7 slaves

Security

Full support of Bluetooth® Security Provisions

Power Management

Microsoft Windows® ACPI, and USB Bus Support
 Self-configurable to optimize power conservation in all operating modes, including Standby, Hold, Park, and Sniff

Certifications

All necessary regulatory approvals for supported countries, including:
 FCC (47 CFR) Part 15C, Section 15.247 & 15.249
 ETS 300 328, ETS 300 826
 Low Voltage Directive IEC950
 UL, CSA, and CE Mark

Bluetooth® Profiles Supported

Serial Port Profile (SPP)¹
 Service Discovery Application Profile (SDAP)
 Dial-Up Networking (DUN)^{1,2}
 Generic Object Exchange Profile (GOEP)^{1,2}
 Object Push Profile (OPP)^{1,2}
 Hard Copy Cable Replacement (HCRP)^{1,2}
 Personal Area Networking Profile (PAN)^{1,2}
 Human Interface Device Profile (HID)^{1,2}
 Advanced Audio Distribution Profile (A2DP)
 Audio Video Remote Control Profile (AVRCP)

Bluetooth® V4.1/V4.2 support feature

V4.1: ESR5/6/7 compliant
 V4.2: ESR8 compliant, LE Secure Connection – Basic.

1. Indicates the profile is supported by Microsoft Windows® XP SP2
 2. Indicates the profile is part of Windows® Vista
 * Wireless access point and internet service required. Availability of public wireless access points limited.

Technical Specifications – Audio/Multimedia

AUDIO/MULTIMEDIA – BANG & OLUFSEN

| | | |
|--------------------------------|----------------------------------|---|
| Hardware | Implementation | Conexant CX7501 |
| | Function Key | Volume up, volume down, and mute |
| | Volume Controls | |
| | Full Duplex | Yes |
| | Microphone In | Stereo |
| | Headphone/Line Out | Stereo |
| | Integrated Microphone | Yes, dual digital microphone array when equipped with optional webcam |
| Audio Output Quality | Frequency Response | 20 Hz - 20 kHz |
| | Signal to Noise Ratio | 106dB (DAC), 102dB (ADC) |
| | Total Harmonic Distortion | 91dB THD+n on LineOut/HP (0.003%) |
| | Noise Floor | -110 dB |
| | Play Sampling Rate(s) | Up to 192kHz |
| | Record Sampling Rate(s) | Up to 96kHz |
| | DAC | 16, 20 or 24-bit |
| | ADC | 16, 20 or 24-bit |
| Internal Stereo Speaker | Power Rating | 1 Watts |
| | Impedance | 4 ohms |

Technical Specifications – Power

POWER

| | | | |
|--------------------------------------|---|--|---|
| HP 150W Slim Smart AC Adapter | Dimensions | 6.02 x 2.60 x .87 in ((153 x 66 x 22 mm) | |
| | Weight | 0.71 lbs (320 g) | |
| | Input | Input | 100 to 240 VAC |
| | | Input Efficiency | 88% min at 115 VAC |
| | | Input frequency range | 47 to 63 Hz |
| | Output | Input AC current | 2.9 A at 90 VAC, 1.45 A at 180 VAC |
| | | Output power | 200W |
| | | DC output | 19.5V |
| | | Hold-up time | 5 msec at 115 VAC input |
| | | Output current limit | <16A, Over voltage protection- 29V max automatic shutdown |
| | Connector | 3 pin/grounded, mates with interchangeable cords | |
| | Environmental Design | Operating temperature | 32° to 104° F (0° to 40° C) |
| | | Non-operating (storage) temperature | -4° to 149° F (-20° to 65° C) |
| | | Altitude | 0 to 10,000 ft (0 to 3,048 m) |
| | | Humidity | 20% to 80% |
| Storage Humidity | | 10% to 90% | |
| EMI and Safety Certifications | CE Mark- full compliance with LVD and EMC directives; Worldwide safety standards- IEC950, EN60950, UL1950, Class 1, SELV; Agency approvals- C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCIB, NOM-1 NYCE; MTBF- over 200,000 hours at 25°C ambient condition. | | |

| | | | | |
|---|-------------------------------|---|-------------------------------|--|
| HP Long Life 4-cell Prismatic Battery (64 WHr) | Dimensions (H x W x L) | 0.29 x 3.35 x 10.2 in (0.74cm x 8.5cm x 25.8cm) | | |
| | Weight (max) | 315g | | |
| | Cells/Type | 4-cell; Prismatic | | |
| | Energy | Voltage | 15.2V | |
| | | Amp-hour capacity | 4.21Ah | |
| | | Watt-hour capacity | 64Wh | |
| | Temperature | Operating (Charging) | 32° to 113° F (0° to 45° C) | |
| | | Operating (Discharging) | 14° to 140° F (-10° to 60° C) | |
| | | Non-operating | -4° to 140° F (-20° to 60° C) | |
| | Battery Re-Charge Time | System in OFF or Standby Mode | 3 hours | |
| System ON | | 3 to 5 hours | | |
| Fuel Gauge LED | No | | | |
| Warranty* | 3 year | | | |

* 3-year platform warranty is required for a 3-year Long Life Battery warranty.

Technical Specifications – Environmental

ENVIRONMENTAL DATA

Eco-Label Certifications & declarations This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- IT ECO declaration
- US ENERGY STAR®
- EPEAT <Gold> registered in the United States. See <http://www.epeat.net> for registration status in your country.

System Configuration The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a “Typically Configured Notebook”.

**Energy Consumption
(in accordance with US
ENERGY STAR® test
method)**

| | 115VAC, 60Hz | 230VAC, 50Hz | 100VAC, 60Hz |
|------------------------------|--------------|--------------|--------------|
| Normal Operation (Sort idle) | 10.62 W | 11.02 W | 10.61 W |
| Normal Operation (Long idle) | 4.58 W | 4.56 W | 4.52 W |
| Sleep | 1.32 W | 1.42 W | 1.38 W |
| Off | 0.55 W | 0.61 W | 0.55 W |

Note:

Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

| Heat Dissipation* | 115VAC, 60Hz | 230VAC, 50Hz | 100VAC, 60Hz |
|-------------------------------|--------------|--------------|--------------|
| Normal Operation (Short idle) | 36 BTU/hr | 38 BTU/hr | 36 BTU/hr |
| Normal Operation (Long idle) | 16 BTU/hr | 16 BTU/hr | 15 BTU/hr |
| Sleep | 5 BTU/hr | 5 BTU/hr | 5 BTU/hr |
| Off | 2 BTU/hr | 2 BTU/hr | 2 BTU/hr |

***NOTE:** Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

**Declared Noise Emissions
(in accordance with
ISO 7779 and ISO 9296)**

| | Sound Power (L _{WAd} , bels) | Sound Pressure (L _{pAm} , decibels) |
|-----------------------------|--|---|
| Typically Configured – Idle | 2.8 | 19 |
| Fixed Disk – Random writes | 2.8 | 19 |

Longevity and Upgrading This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:

Technical Specifications – Environmental

- 2 USB 3.0
- 1 USB 3.0 Charging Port
- 1 SD Card reader
- 2 Thunderbolt™ 3
- 1 HDMI

Spare parts are available throughout the warranty period and or for up to “5” years after the end of production.

Batteries

This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain:
Mercury greater the 1ppm by weight
Cadmium greater than 20ppm by weight

Battery size: 4-cell high capacity Lithium-Ion battery
Battery type: Lithium

Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the <gold> level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product contains 0% post-consumer recycled plastic (by wt.)
- This product is 95.9% recycle-able when properly disposed of at end of life.

Packaging Materials

| | | |
|------------------|-------------------------------------|---------|
| External: | PAPER/Paper | 413.8 g |
| Internal: | PLASTIC/EPE (Expanded Polyethylene) | 42 g |
| | PLASTIC/Polyethylene low density | 11 g |

The plastic packaging material contains at least 68.5% recycled content.

The corrugated paper packaging materials contains at least 75.8% recycled content.

Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at <http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf>):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants – may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates

Technical Specifications – Environmental

- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

Packaging Usage

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

End-of-life Management and Recycling

Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: <http://www.hp.com/go/reuse-recycle> or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: <http://www.hp.com/go/recyclers>. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

Hewlett-Packard Corporate Environmental Information

For more information about HP's commitment to the environment:

Global Citizenship Report

<http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html>

Eco-label certifications

<http://www8.hp.com/us/en/hp-information/environment/ecolabels.html>

ISO 14001 certificates:

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/PC_GBU_Product_Design_ISO_14K_Certificate.pdf

and

<http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf>

COUNTRY OF ORIGIN

China



Options and Accessories (sold separately and availability may vary by country)

| Type | Description | Part # |
|----------------------------|--|-------------|
| Memory | HP 4GB DDR4-2133 SODIMM (Core™ processors only) | T7B76AA |
| | HP 8GB DDR4-2133 SODIMM (Core™ processors only) | T7B77AA |
| | HP 16GB DDR4-2133 SODIMM | TBD |
| | HP 8GB DDR4-2133 EEC SODIMM (Xeon® processors only) | V1D58AA |
| | HP 16GB DDR4-2133 EEC SODIMM (Xeon® processors only) | V1D59AA |
| Cases | HP Executive 15.6 Black Top Load | P6N18AA |
| | HP Business Case (up to 15.6") | H5M92AA |
| Docking | HP Zbook 150W TB3 Dock | P5Q58AA |
| | HP Executive Travel Hub | TOK29AA |
| | HP Travel Hub | TOK30AA |
| | HP 3005pr USB 3.0 Port Replicator | H1L08AA |
| | HP USB-Type C™ Elite Dock | X7W54AA |
| Input/Output - Mice | Comfort Grip Mouse | H2L63AA |
| | HP Stylish USB KB/Mouse | H4B80AA#xxx |
| | HP Slim Bluetooth® Keyboard | H4Q44AA#xxx |
| | HP 3-Button Laser Mouse | H4B81AA#xxx |
| | HP USB Essential Keyboard and Mouse | H6L29AA#xxx |
| | HP Ultra Mobile Wireless Mouse | H6F25AA#xxx |
| | HP Wireless Keyboard and Mouse | G1K29AA#xxx |
| | HP X4000 Bluetooth® Mouse | H3T50AA#xxx |
| | HP Slim Bluetooth® Mouse | F3J92AA#xxx |
| | HP USB Smart Card Reader | F6V67AA |
| | HP Ultrathin Wireless Mouse | L9V78AA |
| | HP Wireless (Link-5) Keyboard | T6U20AA |
| | HP Mobile Hot Spot | M5T50AA |
| | 7.4 to 4.5mm Adapter | K0Q39AA |
| Power Adapters | HP 150W Slim A/C Adapter | TBD |
| | HP 150W Smart AC Adapter (4.5mm) | W2F74AA |
| Adapters | HP Wireless display adapter | J1V25AA#xxx |
| | USB dual output graphics adapter | C5U89AA |
| | HP Conferencing Keyboard | K8P74AA#xxx |
| | HP Speaker Phone | K7V16AA |
| | HP Wired Headset | K7V17AA |
| | HP USB-C™ to VGA Adapter | N9K76AA |
| | HP USB-C™ to DisplayPort Adapter | N9K78AA |
| | HDMI to VGA Adapter | H4F02AA |
| HDMI to DVI adapter | F5A28AA | |

Options and Accessories (sold separately and availability may vary by country)

| | | |
|---------------------------|--|---------|
| Storage - External | HP External USB Optical Drive | F2B56AA |
| Storage | HP 256GB 2280 M2 PCIe 3x4 NVME | TBD |
| | HP 512GB 2280 M2 PCIe 3x4 DS NVME | TBD |
| Security | HP UltraSlim Keyed Cable Lock | H4D73AA |
| | HP Dual Head Cable Lock (Non-Master Key) | T1A64AA |
| | HP Dual Head Cable Lock (Master Key) | T1A65AA |
| | HP 15.6" Notebook PC Privacy Filter | J7H71AA |
| | HP Essential Combination Lock | TOY16AA |
| | HP Combination Lock | TOY15AA |
| | HP Keyed Cable lock | TOY14AA |
| | HP Keyed Cable Lock 10mm | T1A62AA |

NOTE: External power supplies, power cords, cables and peripherals are not low halogen. Service parts obtained after purchase may not be low halogen.

Summary of Changes

| Date of change: | Version History: | | Description of change: |
|--------------------------|------------------|----------------|--|
| | From v1 to v2 | Changed | DisplayPort 1.2 features and ZBook Dock with Thunderbolt 3 in Features section |
| December 18, 2015 | From v2 to v3 | Changed | Docking solution under Options and Accessories |
| January 20, 2015 | From v3 to v4 | Changed | NVIDIA® Quadro® M1000M to HP ZBook Studio special edition: NVIDIA® Quadro® M1000M in At a Glance and Graphics section in features. |
| January 29, 2016 | From v4 to v5 | Added | Battery life in Features |
| | | Changed | Intel HD graphics messaging in At a Glance. |
| February 10, 2016 | From v5 to v6 | Added | Xeon E3-1575M v5 specs, Intel Integrated Graphics messaging, RAID support and notes, HDMI 1.4 version support, and Environmental Data sections. |
| March 31, 2016 | From v6 to v7 | Added | AMO in Options and Accessories |
| | | Changed | Update Bluetooth version from 4.0 to 4.2 (for vPro/non-vPro); 88% min at 115 VAC; Raid 0, 1 supported only on SATA drives; updated battery life and testing to MM14; change the DDR memory spec voltage. |
| June 7, 2016 | From v7 to v8 | Added | HP USB-C Elite Dock in Options and Accessories |
| | | Changed | AC Adapter weight, |
| | | Removed | FDH Touch, Dreamcolor, Iris Pro and Z Turbo Drive 1TB availability footnotes |
| July 1, 2016 | From v8 to v9 | Added | 1 TB Z Turbo, 2.5" 256 SATA SSD, Full HD Touch UHD Panel |
| July 13, 2016 | From v9 to v10 | Added | HP Drivelock note in Software and Security section. |
| August 1, 2016 | From v10 to v11 | Added | Red Hat 6 & 7 (Web Support) and link to support matrix, USB-Type C Elite Dock part number in Options |
| September 1, 2016 | From v11 to v12 | Added | HP 150W Smart AC Adapter (4.5mm) and part number in Options and Accessories, note for hybrid graphics mode for Intel HD graphics 530 |
| | | Changed | Intel core i7, core i5 and Xeon processors in at a glance section |
| January 24, 2018 | From v12 to v13 | Changed | Battery size in Batteries section |
| February 28, 2018 | From v13 to v14 | Added | Note to power supply section |

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